

# **Product Compliance Declaration**

Please see <a href="https://www.molex.com">www.molex.com</a> for the most up-to-date information.

## **Contact Information**

Name Molex Product Compliance E-Mail Product.Compliance@molex.com

## **Part Information**

Part Name KK 100 Hdr FrLk Vert 05 Ckt Gold

## **Product Composition**

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
KK 100 Hdr FrLk Vert 05 Ckt Gold	Assembly		100	0.564073
KK 100 Header FrLk 05 ckt	Component		54.7801	0.309
PA66 WHITE	Material		54.7801	0.309
PA66	Substance		46.5631	0.26265
Flame Retardant, ISO 1043-4 FR(30)	Substance		5.478	0.0309
Further Additives, not to declare	Substance	system	2.739	0.01545
.560 x .0261 Sq Brass Bando Pin 20SAu	Assembly		45.2199	0.255073
.560 x .0261 Sq Brass Bando Pin Unplated	Component		43.4341	0.245
Cartridge Brass 70% Unplated	Material		43.4341	0.245
Copper	Substance	7440-50-8	30.4039	0.1715
Zinc (metal)	Substance	7440-66-6	13.0302	0.0735
Tin Plating	Material		0.4413	0.00249
Tin	Substance	7440-31-5	0.4413	0.00249

#### Form Rev - F

Limitation of this Product Compliance Declaration: This declaration is based on the state of knowledge and belief of Molex as of the date that it is provided. Molex bases its knowledge and belief on information provided by numerous sources, including third parties, and in certain circumstances laboratory test results. Molex has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and substances. Molex represents that to the best of its knowledge that the information provided in this declaration is accurate. Molex's sole liability shall be to either replace the product or refund the purchase price of the product if it does not meet the requirement of this declaration.

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
Nickel Plating	Material		1.1523	0.0065
Nickel	Substance	7440-02-0	1.1522	0.006499
Further Additives, not to declare	Substance	system	0.0001	7E-07
Gold Plating	Material		0.1921	0.001084
Cobalt	Substance	7440-48-4	0.0005	0.000003
Nickel	Substance	7440-02-0	0.0005	0.000003
Gold	Substance	7440-57-5	0.1911	0.001078

# **ROHS Declaration Information**

**Regulatory Revision** EU 2015/863

Compliance Status Compliant

**Contained Substances Exceeding Threshold** 

None

**Exemptions** 

None

# **REACH-SVHC Declaration Information**

**Regulatory Revision** D(2020)4578-DC (25 June 2020)

**Contained Substances Exceeding Threshold** 

None

## **GADSL Declaration Information**

Regulatory Revision GADSL imported from IMDS

#### **Contained Substances Exceeding Threshold**

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
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Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
lead	Cartridge Brass 70% (CA260)	*Note	350	Yes
lead	e-plate Sn (electrodeposited Tin Coatings, bright and matt)	*Note	500	Yes
nickel powder [particle diameter < 1 mm]	e-plate Au (Hardgold) (electrodeposited Hardgold	*Note	2,500	Yes
nickel powder [particle diameter < 1 mm]	Ep-Ni	*Note	997,500	Yes
Cobalt	e-plate Au (Hardgold) (electrodeposited Hardgold	*Note	2,500	Yes
copper	Cartridge Brass 70% (CA260)	*Note	700,000	Yes

<sup>\*</sup>Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

## **Exemptions**

Part Name	Exemption
Cartridge Brass 70% (CA260)	44 Concentration within acceptable GADSL limits
e-plate Sn (electrodeposited Tin Coatings, bright and matt)	44 Concentration within acceptable GADSL limits
e-plate Au (Hardgold) (electrodeposited Hardgold Coatings)	34 Not applicable
Ep-Ni	33 Other application (Surface not routinely touched or nickel release rate < 0.5µg/cm2/week)

# **HFLH Declaration Information**

Regulatory Revision IEC 61249-2-21

## **Contained Substances Exceeding Threshold**

None

## **China ROHS Declaration Information**

Part Number 0022112052							
Part Name KK 100 Hdr FrLk Vert 05 Ckt Gold	<b>(e)</b>						
Part Information			Haz	zardous S	Substance	es	
Components		Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
KK 100 Hdr FrLk Vert 05 Ckt Gold		0	0	0	0	0	0
KK 100 Header FrLk 05 ckt		0	0	0	0	0	0

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Components	Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
.560 x .0261 Sq Brass Bando Pin 20SAu	0	0	0	0	0	0
.560 x .0261 Sq Brass Bando Pin Unplated	0	0	0	0	0	0

## **Process Information**

Component Plating / Surface Finish	MSn-Ni
Termination Base Alloy	Brass
Solder Alloy	N/A
Process Capability	WAVE
Maximum Exposure Time (seconds)	005
Maximum Process Temperature (C)	235
Maximum Cycles at Reflow Temperature	001
J-STD-020 Moisture Sensitivity Level	N/A

Jan 11, 2021